

FQPF7N40 **400V N-Channel MOSFET**

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply, electronic lamp ballast based on half bridge.

Features

- 4.6A, 400V, R_{DS(on)} = 0.8Ω @V_{GS} = 10 V
 Low gate charge (typical 16.5 nC)
- Low Crss (typical 13 pF)
- Fast switching
- · 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQPF7N40	Units
V _{DSS}	Drain-Source Voltage		400	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		4.6	A
	- Continuous (T _C = 100°C)	2.9	A
I _{DM}	Drain Current - Pulsed	(Note 1)	18.4	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	360	mJ
I _{AR}	Avalanche Current	(Note 1)	4.6	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	4.2	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
PD	Power Dissipation (T _C = 25°C)		42	W
	- Derate above 25°C		0.34	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes,		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case		2.98	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

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ТМ

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	400			V
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$		0.43		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 400 V, V _{GS} = 0 V			1	μA
		V _{DS} = 320 V, T _C = 125°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	rootoriotioo					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =2.3A		0.62	0.8	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.3 \text{ A}$ (Note 4)		5.4		S
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		600	780	pF
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		600	780	pF
	Deverse Transfer Conseitence	f = 1.0 MHz		105	130	рг
Orss	Reverse transier Capacitance			15	17	рі
Switchi	ng Characteristics					
t _{d(on)}	Turn-On Delay Time	$V_{pp} = 200 V l_{p} = 7 A$		20	50	ns
t _r	Turn-On Rise Time	$B_{0} = 250$		75	160	ns
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		50	110	ns
Qg	Total Gate Charge	V _{DS} = 320 V, I _D = 7 A,		16.5	22	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$		4.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		8.5		nC
				1		1
Drain-S	Source Diode Characteristics and Maximum Ratings			[4.0	
IS	Maximum Continuous Drain-Source Diode Forward Current				4.6	A
ISM	Maximum Pulsed Drain-Source Diode F	-orward Current			18.4	A
'SM	Drain-Source Diode Forward Voltage $V_{GS} = 0 V, I_S = 4.6 A$				1.5	A V

 V_{GS} = 0 V, I_S = 7 A,

 dI_F / dt = 100 A/µs

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(Note 4)

220

1.3

ns

μC

Q _{rr}	
Notoo	

t_{rr}

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 30mH, I_{AS} = 4.6A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq 7A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS} Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Reverse Recovery Time

Reverse Recovery Charge

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Rev. A, April 2000



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